

Product Summary

Device	BV _{DSS}	RDS(ON) Max	I _D T _A = +25°C
Q1	100V	160mΩ @ V _{GS} = 10V	2.0A
N-Channel	100 v	200mΩ @ V _{GS} = 4.5V	1.5A
Q2	-100V	250mΩ @ VGs = -10V	-1.7A
P-Channel	-1000	300mΩ @ V _{GS} = -4.5V	-1.3A

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

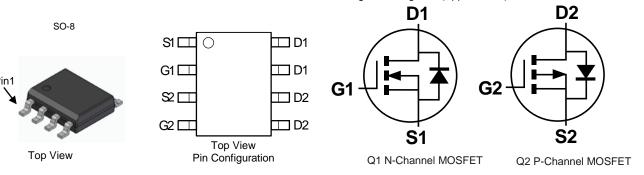
Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC converters
- Power management functions
- Backlighting

Mechanical Data

- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.074 grams (Approximate)



Ordering Information (Note 4)

Part Number	Baakaga	Packing			
Fart Nulliper	Package	Qty.	Carrier		
DMC10H172SSD-13	SO-8	2,500	Tape & Reel		

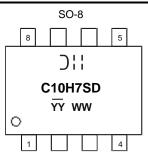
NI 4			
Notes:	1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/80	ant	
140100.		un.	

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\begin{array}{l} \label{eq:constraint} \exists \mathsf{Manufacturer's} \ \mathsf{Marking} \\ \hline \mathsf{C10H7SD} = \mathsf{Product} \ \mathsf{Type} \ \mathsf{Marking} \ \mathsf{Code} \\ \hline \hline \mathsf{YY} \\ \mathsf{WW} = \mathsf{Date} \ \mathsf{Code} \ \mathsf{Marking} \\ \hline \hline \mathsf{YY} \\ = \mathsf{Year} \ (\mathsf{ex:} \ 22 = 2022) \\ \\ \mathsf{WW} = \mathsf{Week} \ (\mathsf{01} \ \mathsf{to} \ \mathsf{53}) \end{array}$



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Q1	Q2	Units
Drain-Source Voltage			VDSS	100	-100	V
Gate-Source Voltage			V _{GSS}	±20	±20	V
Continuous Drain Current (Note 6)Steady $T_A = +25^{\circ}C$ Q1: $V_{GS} = 10V$ State $T_A = +70^{\circ}C$ Q2: $V_{GS} = -10V$ State $T_A = +70^{\circ}C$			lo	2.0 1.6	-1.7 -1.4	A
Maximum Body Diode Forward Current (Note 6)			ls	2.0	-1.7	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	16	-13	A
Avalanche Current, L = 1.43mH			las	5.3	-6	А
Avalanche Energy, L = 1.43mH			E _{AS}	20	25	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5)		PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	110	°C/W
Total Power Dissipation (Note 6)		PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	80	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics N-Channel Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						·
Drain-Source Breakdown Voltage	BVDSS	100	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 100V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	VGS(TH)	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance	Deserve	_	103	160	mΩ	V _{GS} = 10V, I _D = 1.6A
Static Drain-Source On-Resistance	R _{DS(ON)}	_	110	200	11122	V _{GS} = 4.5V, I _D = 1.3A
Diode Forward Voltage	Vsd	_	0.7	1.2	V	VGS = 0V, IS = 1.1A
DYNAMIC CHARACTERISTICS (Note 8)	-					
Input Capacitance	Ciss		1145	—		
Output Capacitance	Coss	_	26	—	pF	$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz
Reverse Transfer Capacitance	Crss	_	20	_		
Gate Resistance	Rg	_	1.3	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	9.6	_		
Total Gate Charge (VGS = 10V)	Qg	_	19.6	_		
Gate-Source Charge	Qgs	_	2.7	_	nC	$V_{DS} = 50V, I_D = 1A$
Gate-Drain Charge	Q _{gd}	_	3.3	_		
Turn-On Delay Time	tD(ON)	_	9	_		
Turn-On Rise Time	tR	_	13			$V_{DS} = 50V, V_{GS} = 4.5V,$
Turn-Off Delay Time	tD(OFF)	_	22	_	ns	$R_G = 6.8\Omega$, $I_D = 1A$
Turn-Off Fall Time	tF	_	7.5	—		
Body Diode Reverse Recovery Time	t _{RR}	_	19	_	ns	1 4 A 11/14 400A/
Body Diode Reverse Recovery Charge	QRR		14	_	nC	IF = 1A, di/dt = 100A/µs

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



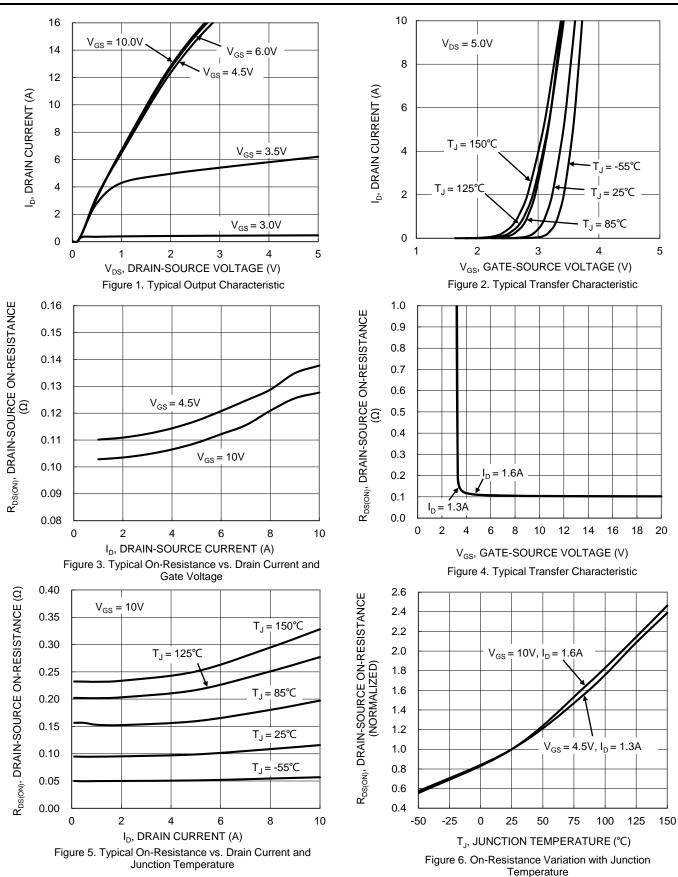
Electrical Characteristics P-Channel Q2 (@TA = +25°C, unless otherwise specified.)

			_			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)		1				
Drain-Source Breakdown Voltage	BVDSS	-100	—	—	V	$V_{GS} = 0V, I_{D} = -250 \mu A$
Zero Gate Voltage Drain Current	IDSS	_	—	-1	μA	$V_{DS} = -100V, V_{GS} = 0V$
Gate-Source Leakage	IGSS		—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	VGS(TH)	-1.0	—	-3.0	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$
Static Drain-Source On-Resistance	Descer		195	250	mΩ	Vgs = -10V, ID = -1A
Static Dialit-Source Off-Resistance	RDS(ON)		210	300	1112	VGS = -4.5V, ID =-1A
Diode Forward Voltage	V _{SD}	_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		1030	_		
Output Capacitance	Coss		33	_	pF	V _{DS} = -50V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	24	_		
Gate Resistance	Rg	_	13	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	9	_		
Total Gate Charge (V _{GS} = -10V)	Qg	_	18	_	nC	$V_{DS} = -50V$. ID = -1A
Gate-Source Charge	Qgs	_	2	_	nc	$v_{DS} = -50v, I_D = -IA$
Gate-Drain Charge	Q _{gd}	_	1.9	_		
Turn-On Delay Time	td(on)	_	8	_		
Turn-On Rise Time	tR	_	16	_		
Turn-Off Delay Time	t _{D(OFF)}	_	36	_	ns	$V_{DD} = -50V, R_G = 9.1\Omega, I_D = -1A$
Turn-Off Fall Time	tF		18	_]	
Body Diode Reverse Recovery Time	trr		16	_	ns	
Body Diode Reverse Recovery Charge	Q _{RR}	_	11		nC	$I_F = -1A$, di/dt =100A/µs

Notes:7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing.



N-Channel





DMC10H172SSD

 $I_D = 1mA$

75

60 70 80 90 100

1s

DC

10

100

125

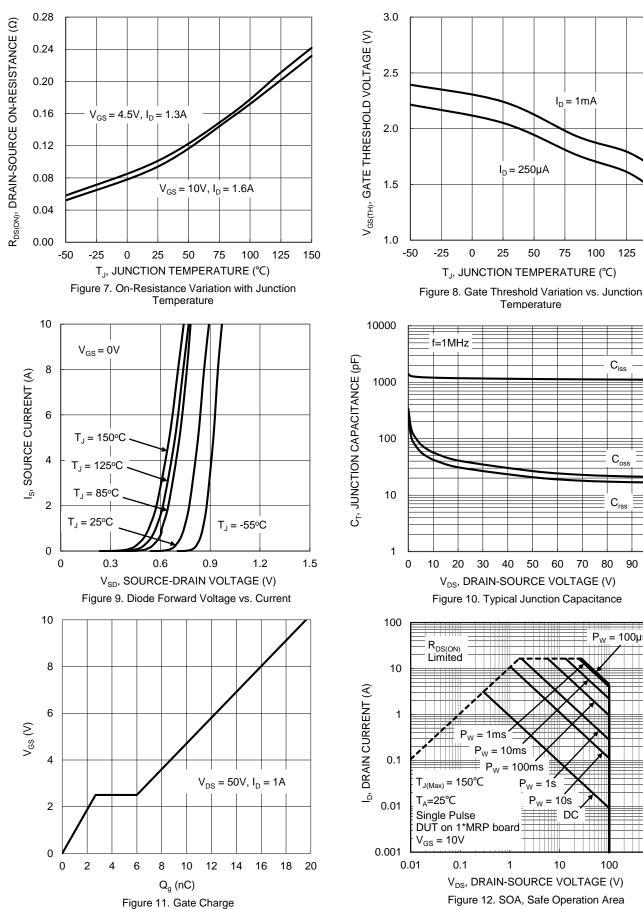
Ciss

Coss

 $\mathbf{C}_{\mathrm{rss}}$

 $P_W = 100 \mu s$

150

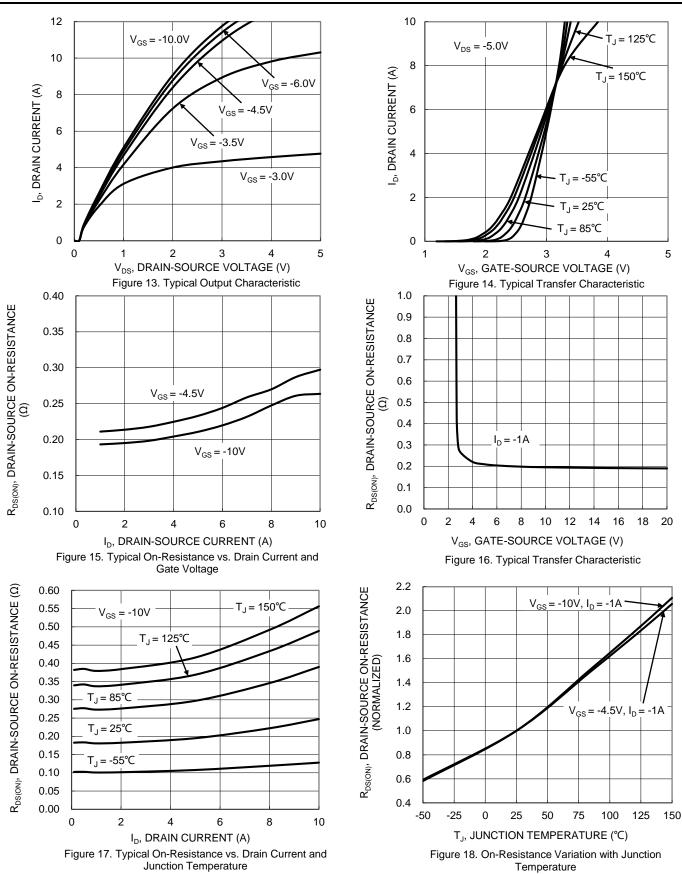


DMC10H172SSD Document number: DS43992 Rev. 2 - 2 100

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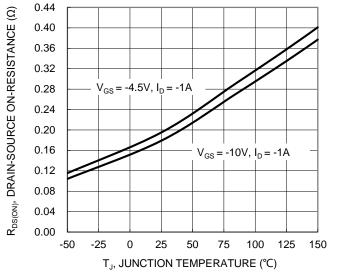


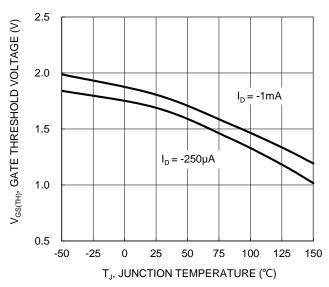
P-Channel

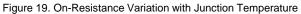


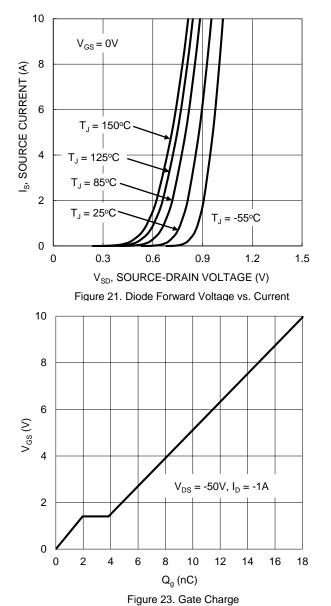


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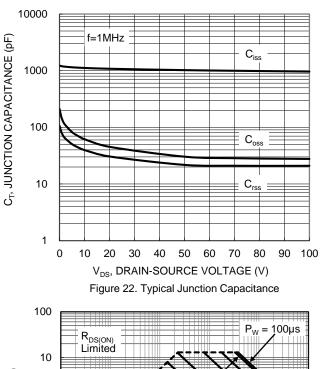


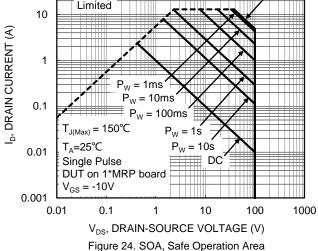




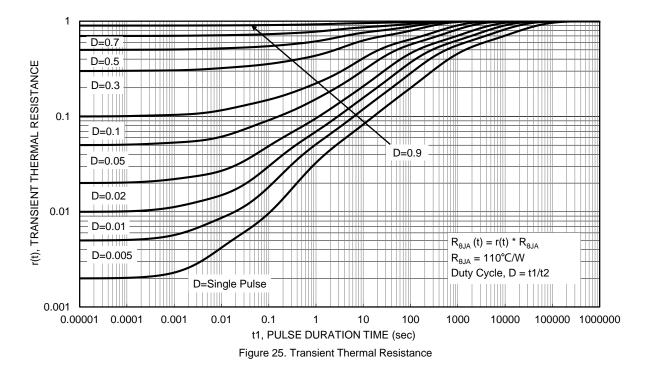








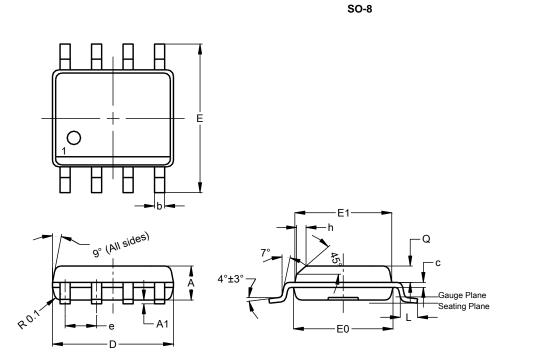






Package Outline Dimensions

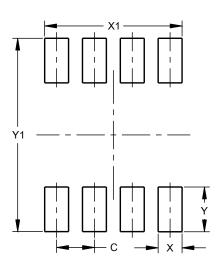
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SO-8						
Dim	Min	Min Max Typ					
Α	1.40	1.50	1.45				
A1	0.10	0.20	0.15				
b	0.30	0.50	0.40				
C	0.15	0.25	0.20				
D	4.85	4.95	4.90				
ш	5.90	6.10	6.00				
E1	3.80	3.90	3.85				
E0	3.85	3.95	3.90				
е			1.27				
h			0.35				
L	0.62	0.82	0.72				
Q	0.60	0.70	0.65				
All	Dimens	sions in	mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8

Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



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